Messrs. Digi-Key

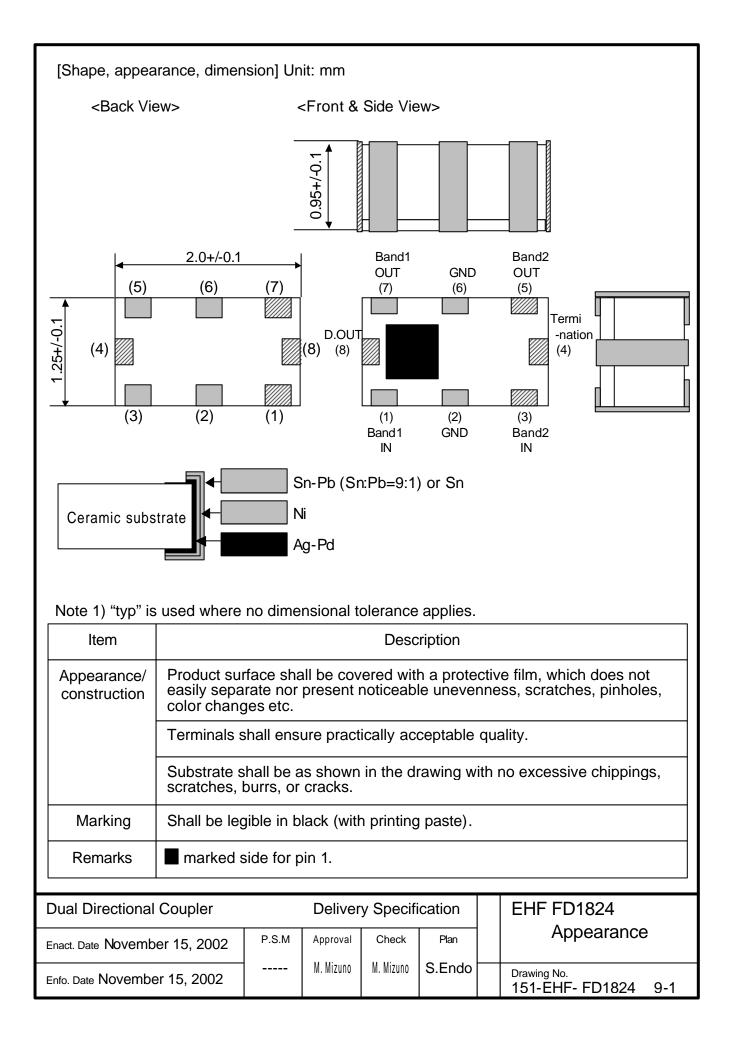
Issue No.: PC-02-054Date of issue : November 15, 2002Classification :■ New □ Change □ Renewal

Delivery Specification

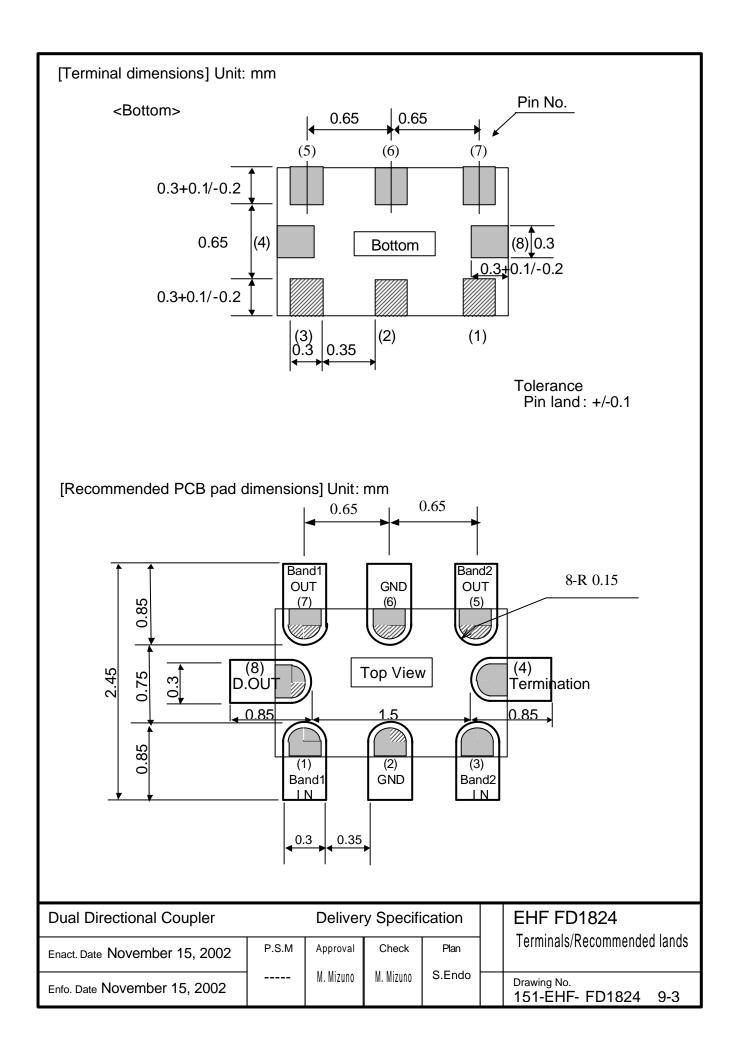
Product Description	: Dual Band Directional Coupler
Product Part Number	: EHFFD1824
Classification of Spec	: Individual Product Specification
Applications	: Cellular phone
	For other applications, contact the undersigned in advance.
Term of Validity	: November 14, 2007 from the date of issue.

CUSTOMER USE ONLY	Receipt Record#:	
This was certainly received by us. 1(one) copy is being returned to you.	Date of receipt:	
r(one) copy is being returned to you.	Received by:	
	Title: Dept.:	

Matsushita Electronic Components Co., Ltd.		
Network Device Company	Prepared by	: S.Endo
Module Strategic Business Unit	Checked by	: M. Mizuno
Engineering Group HFD Team		
992-1 Aiba Ohno-cho Ibi-gun Gifu 501-0598 JAPAN	Authorized by	: M. Mizuno
Tel: +81-0585-36-2322	Title	: Manager of Engineering
Fax: +81-0585-36-2344		. Manager of Engineering



[Absolute maximum rating	asl						
No. Item		Symbol Rating L			Unit	Rema	rk
1 Maximum Input Pov		Pmax 3.2/1.5(Band1/2)		W	DC bias is zero.		
2 Operating Tempera		· · · · · · · · · · · · · · · · · · ·		degC			
3 Storage Temperatur			-40~+85		degC		
Note: This component cannot apply a DC Bias. [Characteristics] T= 25 +/- 5 degC							
No. Item		Test		Si	pecific	ation	Unit
		Circuit	min.		typ.		-
1 Frequency range B	and1	Fig.1	880		-	915	MHz
2 Frequency range B	and2	Fig.1	1710		-	1785	MHz
	and1	Fig.1	-		-	0.45	dB
	and2	Fig.1	-		-	0.45	dB
	and1	Fig.1	13.0		14.0		dB
	and2	Fig.1	13.0		14.0) 15.0	dB
	and1	Fig.1	18.0		-	-	dB
	and2	Fig.1	18.0		-	-	dB
9 Input V.S.W.R. in both	Bands	Fig.1	-		-	1.5	-
*1 not include Test Board Loss Band1 : 0.10 dB Band2 : 0.15 dB (7) Band1 OUT (
(4) Termination () (5) Band2 OUT () (5)				(8) O	D.OUT		
 [Test Circuit Diagram] Fig.1 Image: Strate of the stra							
Dual Directional Coupler		Delivery Specification				EHF FD1824	
Enact. Date November 15, 2002	P.S.M	Approval	Check	Plan	Specification and meas		measurement
Enfo. Date November 15, 2002	╡	M. Mizuno	M. Mizuno	S.Endo		Drawing No.	



[Quality characteristic	s]				
Test item	Test condition	Judgment criteria			
High temperature	+85degC, 1000h	No abnormality shall			
Low temperature	-40degC, 1000h	be observed in appearance or			
High-temperature high-humidity storage	+60degC, 90%RH, 1000h	electrical characteristics.			
Pressure Pot	+121degC, 99%RH, 2.026x10 ⁵ Pa, 100h	characteristics.			
Temperature cycling	-40…+85degC, Each 30 min., 200cy				
Vibration	10500Hz, 10G, in each direction of XYZ, 2h30min.				
Impact	100G, 6mS, Half sinusoidal wave, in each direction of XYZ, 3 times				
Shock (Drop)	1.8m, 6 facesx6cy(36 times with 100g Dummy Load)				
Electro static discharge	200pF, 0 ohm, +/-200V, Each 5 times				
Soldering heat resistance	Manual hot gas: 260+/-10degC, 30 sec., 2 times	Over 90% of the terminal			
	Soldering iron: 260+/-10degC, 3 sec., 2 times	surface shall be covered with solder.			
	Reflow: 260degC peak, 2 times				
Solder ability	Solder bath: 235+/-5degC, 2 sec.	Over 95% of the terminal			
	Reflow: 230degC	surface shall be covered with solder.			
Board warping	Assemble this component on a PC board with 0.8mm thickness using the recommended soldering condition shown below, and apply a bending force of 3mm warping at a rate of 1mm/sec. 5 seconds and 5 times. t=0.8mm	There should not be any cracks in the component or solder joints, no abnormality in electrical characteristics.			
Terminal removal	Solder a component on a PC board using the recommended of then press the component sideways at 1mm/sec. Destruction lir				
Seating plane co-planarity	Within 0.1mm				
< Recommended sold Diagram1 Shown b degC 250 230 230 170 140	below is a recommended reflow soldering condition				
	30~60 sec. 60~180 sec. ►	Time			
Dual Directional Coupler Delivery Specification EHF FD1824					
Enact. Date November 15, 2	002 P.S.M Approval Check Plan Qua	lity Characteristics			
Enfo. Date November 15, 20	^{g No.} EHF- FD1824 9-4				

[Cautions for use]

(1) Operating a product over the maximum rating for even a moment may result in a
product failure or breakage. Never use a product in such a condition that it may
cause a safety problem.

- (2) Opening or short-circuiting the product terminals or inserting a product in the reverse orientation while power is being supplied may cause a breakage. Always avoid such circumstances.
- (3) Operations in a corrosive gas atmosphere or improper environments such as hightemperature, high-humidity or dewy conditions may lead to product performance deterioration, a breakage, a change in appearance etc. Please avoid such conditions, as they are unsafe.
- (4) Always ground the soldering iron or soldering bath used for assembly operation to avoid any excessive voltage applied to a product.
- (5) After soldering with solder bridges, incomplete soldering or in the reverse orientation, supplying power may result in a product breakage. Please confirm the soldered condition before supplying power to the product.
- (6) Excessive stress on the terminals may cause a contact failure or performance deterioration. Please use caution.
- (7) Please provide a fail-safe provision in the product you design by taking any failure of our product into consideration.
- (8) This product does not include a DC-cutting device. Application of a DC Current may cause product deterioration or breakage.
 - * If any question arises about the safety of this product, please contact us immediately with a request for an engineering examination.

[Remarks]

- *1: All of the materials used in this product are those listed as the existing chemical substances based on the "Law for examination and regulation of manufacture of chemical substances".
- *2: The production process of this product does not use any ozone-depleting chemicals (OZC) regulated by the Montreal Protocol.
- *3: Validity of this specification is 5 years from the date of issue, but the validity is considered on going unless any changes are made.

Dual Directional Coupler	al Directional Coupler Delivery Specification				EHF FD1824
Enact. Date November 15, 2002	P.S.M	Approval	Check	Plan	Cautions
Enfo. Date November 15, 2002		M. Mizuno	M. Mizuno	S.Endo	Drawing No. 151-EHF- FD1824 9-5

[Packaging materials] 1. Materials 1)

- Embossed carrier tape (Refer to the attachment)
 Top tape: Anti-static
- 3) Packaging box (Refer to the attachment)4) Packaging tape, carrier-securing adhesive tape
- 2. Specification

No.	Item	Condition	1					
1		Condition	Remarks					
	Reel outer diameter	Refer to the attachment.						
2	Reel inner diameter	Refer to the attachment.						
3	Reel inner width	Refer to the attachment.						
4	Quantity in a reel	4000 pieces/reel						
5	Taping direction	Tape unreeling direction (with markings facing up)						
	Top tape attachment position	Top tape 8.0+/-0.2mm Top tape attachment area > Top tape attachment area > Top tape attachment area > Top tape attachment area > Top tape attachment area > Embossed tape Top tape attachment area > Embossed tape Top tape attachment area > Top tape attachmen	Tape breaks force. Min. 10N Top cover tape strength. Min. 10N Tape peel force. 0.11.0N Tape peel angle. 165180degree Reel weight. Max 1500g					
	Label attachment position	Tape unreeling direction	Indicated Item Pat No., Lot No. Quantity, Maker Country of Origin					
	Tape leader part and tape ending part	Leader part Leader part Leader part For tape 200~220mm (Product-unloaded part) 100~150mm, 25~38 pieces worth, (Product-unloaded part) 300~ 400mm						
9	9 Missing products No missing products shall be allowed.							
10Packaged quantity in a box21 reels/box (Max)84000 pieces/box(Max)								
	I Directional Coup	-D1824 ging specification 1						
	Date November 15, 2 Date November 15, 2	M. Mizuno M. Mizuno S.Endo Drawing M	^{No.} HF- FD1824 9-6					

